ASSOCIATION ELECTRONICS	CONNECTING S INDUSTRIES® international and Par	PC, Bannockb	ourn, Illinois. A	All rights reserved untions.	nder both	This docume level parts, t	ent is a declarati he declaration e	on of the sub ncompasses a	stances wi all lower le	ithin the manufactur evel materials for w	rer listed i hich the n	tem. Note: if nanufacturer	the item is an as has engineering	ssembly with low responsibility.	
752-21.1					Form Type Distribute					omogeneous Materi	tials and Mfg Information				
upplier	Information														
ompany 1	name*	Company unique ID			1	Unique ID Authority				Response Date*					
nsemi										2025-06-06					
ontact Na	ame	Title - Contact]	Phone - Contact*				Email - Contact*					
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized	l Representative*	Title - Representative]	Phone - Representative*				Email - Representative*					
roduct-E	Cnv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
			Number Mfr Item Name				Effective Date	Version	on Manufacturing Site			Weight*	UOM	Unit Type	
			6PW DARL VDE	PW DARL VDE		2025-06-06 T		TH	ТНН		445.072	mg	Each		
Ianufac	cturing Proccess Informa	tion													
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-		J-STD-020 MS	L Rating	Peak Process Body		dy Temperature Max Time at Peak		Temperature Number of Reflow Cy		er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		CU Alloy NA			0 C		С	30 se		ds 3					
omments															
or more i	nformation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed									
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron		0.1% by mass (1000 PPM) in homogeneous material for: Lead DE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of									
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted										
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.														
Exemption List Version	EL-2011/534/EU													
Declaration Signature														
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the									
Supplier Digital Signature Ra	stislav Drska	Le												

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measur
Coupling Gel	0.4	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.04	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		0.36	mg
Die	0.37	mg	Supplier	Silicon (Si)	7440-21-3		0.37	mg
Die Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.246	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.054	mg
Die GaAs	0.11	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.11	mg
Lead Frame	108.322	mg	Supplier	Silver (Ag)	7440-22-4		0.68	mg
			Supplier	Zinc (Zn)	7440-66-6		0.13	mg
			Supplier	Iron (Fe)	7439-89-6		2.48	mg
			Supplier	Copper (Cu)	7440-50-8		105	mg
			Supplier	Phosphorus (P)	7723-14-0		0.032	mg
Mold Compound-White	327.22	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		81.805	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		9.8166	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		44.1747	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		9.8166	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		163.61	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		17.9971	mg
Plating	6.7	mg	Supplier	Tin (Sn)	7440-31-5		6.7	mg
Wire Bond - Au	1.65	mg	Supplier	Gold (Au)	7440-57-5		1.65	mg